

30 V, 200 mA P-channel Trench MOSFET Rev. 1 — 1 August 2011

Product data sheet

Product profile 1.

1.1 General description

P-channel enhancement mode Field-Effect Transistor (FET) in a small SOT323 (SC-70) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

1.2 Features and benefits

- Very fast switching
- Low threshold voltage
- Trench MOSFET technology

1.3 Applications

- Relay driver
- High-speed line driver

1.4 Quick reference data

- ESD protection up to 2 kV
- AEC-Q101 qualified
- High-side loadswitch
- Switching circuits

Quick reference data					
Parameter	Conditions	Min	Тур	Max	Unit
drain-source voltage	T _j = 25 °C	-	-	-30	V
gate-source voltage		-8	-	8	V
drain current	V_{GS} = -4.5 V; T_{amb} = 25 °C	<u>[1]</u> _	-	-200	mA
aracteristics					
drain-source on-state resistance	V_{GS} = -4.5 V; I_D = -200 mA; T_j = 25 °C	-	2.8	4.1	Ω
	Parameterdrain-source voltagegate-source voltagedrain currentaracteristicsdrain-source on-state	ParameterConditionsdrain-source voltage $T_j = 25 \ ^{\circ}C$ gate-source voltagedrain currentdrain current $V_{GS} = -4.5 \ V; \ T_{amb} = 25 \ ^{\circ}C$ aracteristicsdrain-source on-stateV_{GS} = -4.5 \ V; \ I_D = -200 \ mA;	ParameterConditionsMindrain-source voltage $T_j = 25 \ ^{\circ}C$ -gate-source voltage-8drain current $V_{GS} = -4.5 \ V; \ T_{amb} = 25 \ ^{\circ}C$ [1] -aracteristics-4.5 \ V; \ I_D = -200 \ mA;-	ParameterConditionsMinTypdrain-source voltage $T_j = 25 \ ^\circ C$ gate-source voltage-8-drain current $V_{GS} = -4.5 \ V; \ T_{amb} = 25 \ ^\circ C$ [1]-aracteristicsdrain-source on-state $V_{GS} = -4.5 \ V; \ I_D = -200 \ mA;$ -2.8	ParameterConditionsMinTypMaxdrain-source voltage $T_j = 25 \ ^{\circ}C$ 30gate-source voltage-8-8drain current $V_{GS} = -4.5 \ V; \ T_{amb} = 25 \ ^{\circ}C$ [1]200aracteristicsdrain-source on-state $V_{GS} = -4.5 \ V; \ I_D = -200 \ mA;$ -2.84.1

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².

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2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	S	source		
3	D	drain	1 ☐ ☐ 2 SOT323 (SC-70)	G G S 017aaa259

3. Ordering information

Table 3.	Ordering in	formation		
Type number Package		Package		
		Name	Description	Version
NX3008PB	KW	SC-70	plastic surface-mounted package; 3 leads	SOT323

4. Marking

Table 4. Marking codes	
Type number	Marking code ^[1]
NX3008PBKW	AB%

[1] % = placeholder for manufacturing site code

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5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C	-	-30	V
V _{GS}	gate-source voltage		-8	8	V
I _D	drain current	V_{GS} = -4.5 V; T_{amb} = 25 °C	<u>[1]</u> _	-200	mA
		V_{GS} = -4.5 V; T_{amb} = 100 °C	<u>[1]</u> _	-130	mA
I _{DM}	peak drain current	$T_{amb} = 25 \text{ °C}$; single pulse; $t_p \le 10 \mu\text{s}$	-	-0.8	А
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2] _	260	mW
			<u>[1]</u> _	310	mW
		T _{sp} = 25 °C	-	830	mW
Tj	junction temperature		-55	150	°C
T _{amb}	ambient temperature		-55	150	°C
T _{stg}	storage temperature		-65	150	°C
Source-drai	n diode				
I _S	source current	T _{amb} = 25 °C	<u>[1]</u> _	-200	mA
ESD maxim	um rating				
V _{ESD}	electrostatic discharge voltage	НВМ	[3]	2000	V

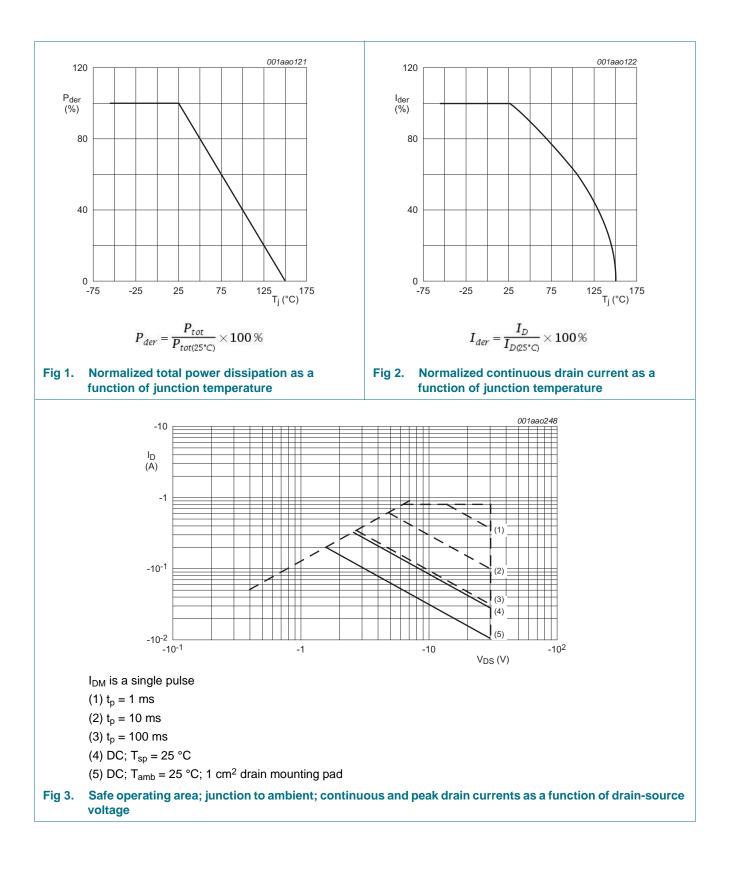
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[3] Measured between all pins.

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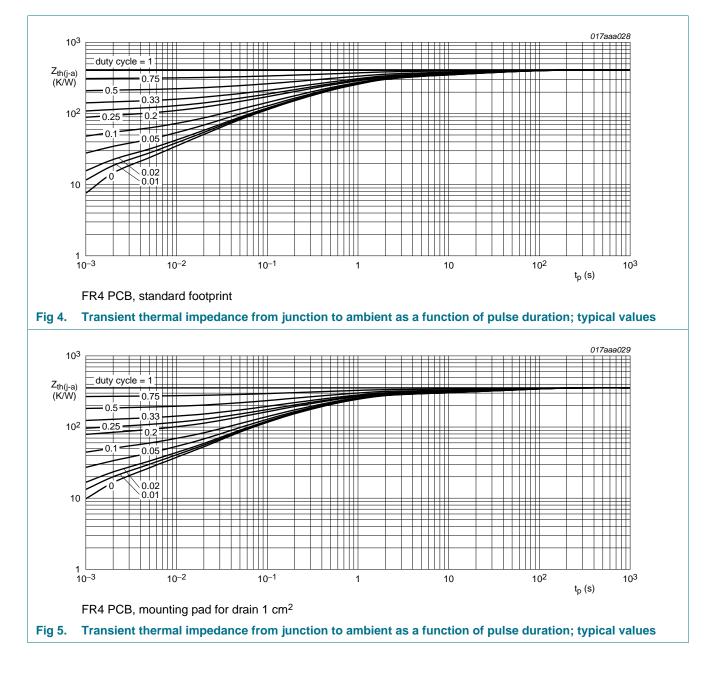
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Thermal characteristics 6.

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	415	480	K/W
			[2] _	350	400	K/W
R _{th(j-sp)}	thermal resistance from junction to solder poin	t	-	-	150	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².



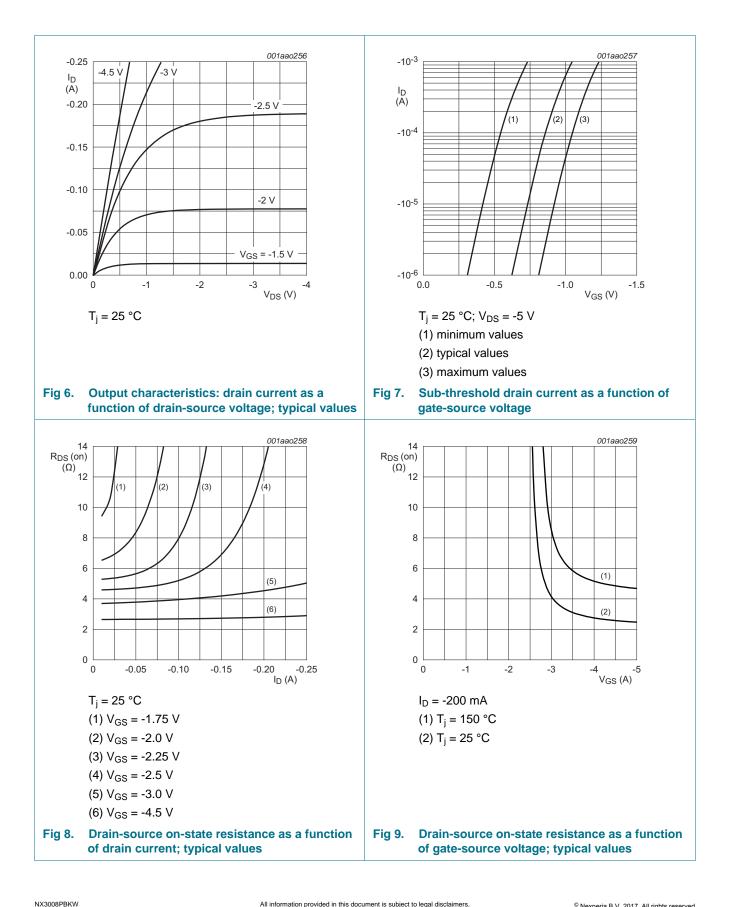
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7. Characteristics

Table 7.	Characteristics	- ···		_		
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static cha	aracteristics					
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = -250 \ \mu\text{A}; \ V_{GS} = 0 \ \text{V}; \ T_j = 25 \ ^\circ\text{C}$	-30	-	-	V
V _{GSth}	gate-source threshold voltage	I_D = -250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	-0.6	-0.9	-1.1	V
I _{DSS}	drain leakage current	$V_{DS} = -30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 \text{ °C}$	-	-	-10	μA
		$V_{DS} = -30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	-1	μA
I _{GSS}	gate leakage current	$V_{GS} = 8 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-0.2	-1	μA
		$V_{GS} = -8 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-0.2	-1	μA
		V_{GS} = 4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-10	-	nA
		V_{GS} = -4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-10	-	nA
		V_{GS} = 2.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-1	-	nA
		V_{GS} = -2.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-1	-	nA
R _{DSon}	drain-source on-state resistance	V_{GS} = -4.5 V; I_D = -200 mA; T_j = 25 °C	-	2.8	4.1	Ω
		V_{GS} = -4.5 V; I_D = -200 mA; T_j = 150 °C	-	5.3	7.8	Ω
		V_{GS} = -2.5 V; I_{D} = -10 mA; T_{j} = 25 °C	-	5.3	6.5	Ω
9 _{fs}	forward transconductance	V_{DS} = -10 V; I_{D} = -200 mA; T_{j} = 25 °C	-	160	-	mS
Dynamic	characteristics					
Q _{G(tot)}	total gate charge	$V_{DS} = -15 \text{ V}; I_D = -200 \text{ mA};$	-	0.55	0.72	nC
Q _{GS}	gate-source charge	V _{GS} = -4.5 V; T _j = 25 °C	-	0.23	-	nC
Q _{GD}	gate-drain charge		-	0.09	-	nC
C _{iss}	input capacitance	$V_{DS} = -15 \text{ V}; \text{ f} = 1 \text{ MHz}; V_{GS} = 0 \text{ V};$	-	31	46	pF
C _{oss}	output capacitance	$T_j = 25 \ ^{\circ}C$	-	6.5	-	pF
C _{rss}	reverse transfer capacitance		-	2.3	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = -20 V; R_L = 250 Ω ; V_{GS} = -4.5 V;	-	19	38	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	30	-	ns
t _{d(off)}	turn-off delay time		-	65	130	ns
t _f	fall time		-	38	-	ns
Source-d	rain diode					
V _{SD}	source-drain voltage	I _S = -200 mA; V _{GS} = 0 V; T _i = 25 °C	-0.47	-0.88	-1.2	V

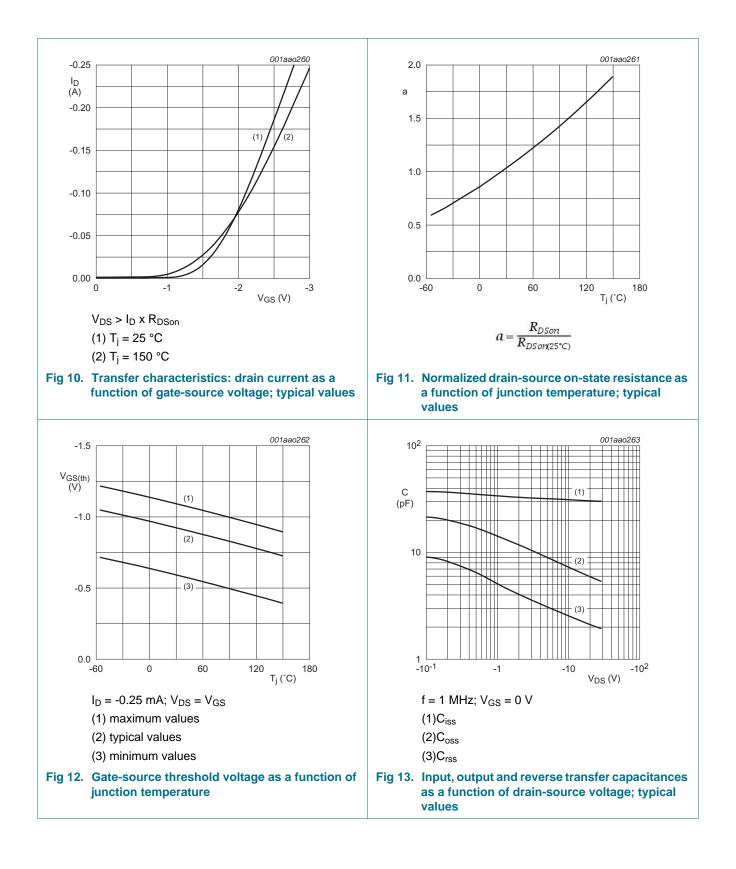
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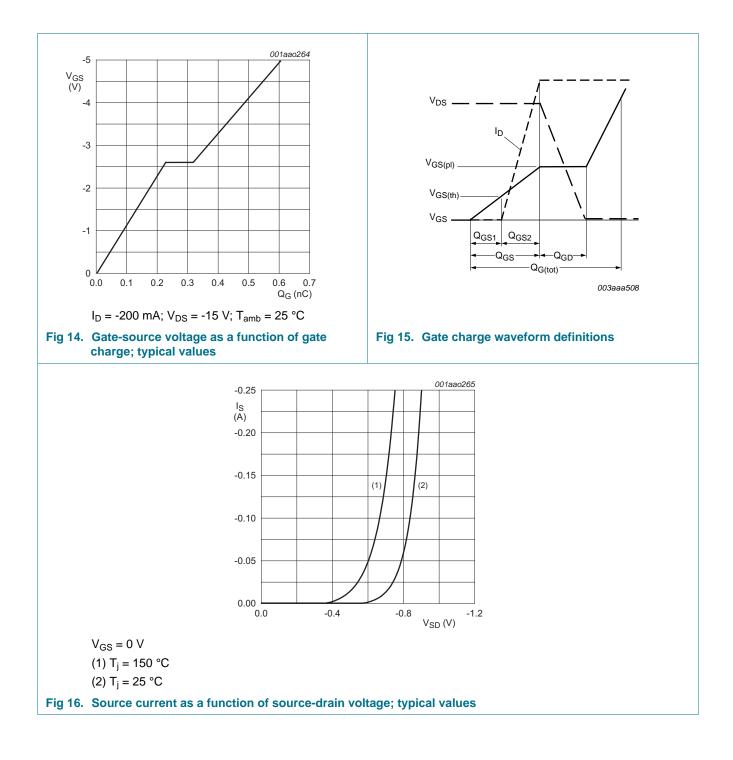
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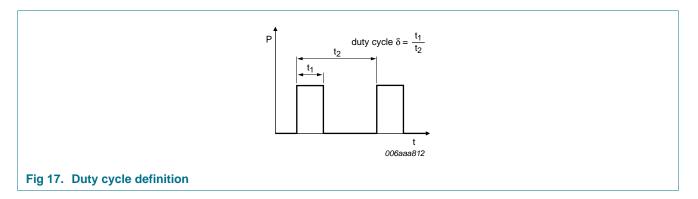
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8. Test information



8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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9. Package outline

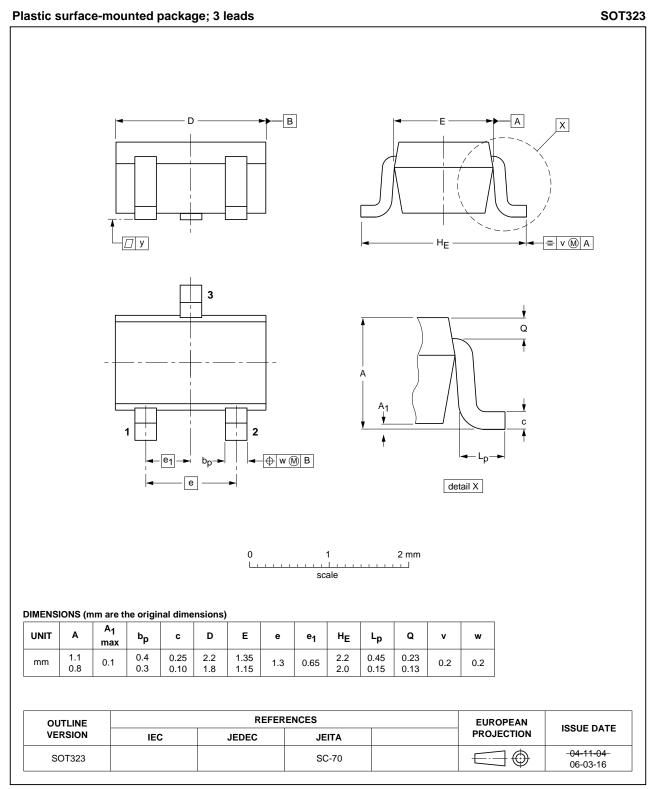


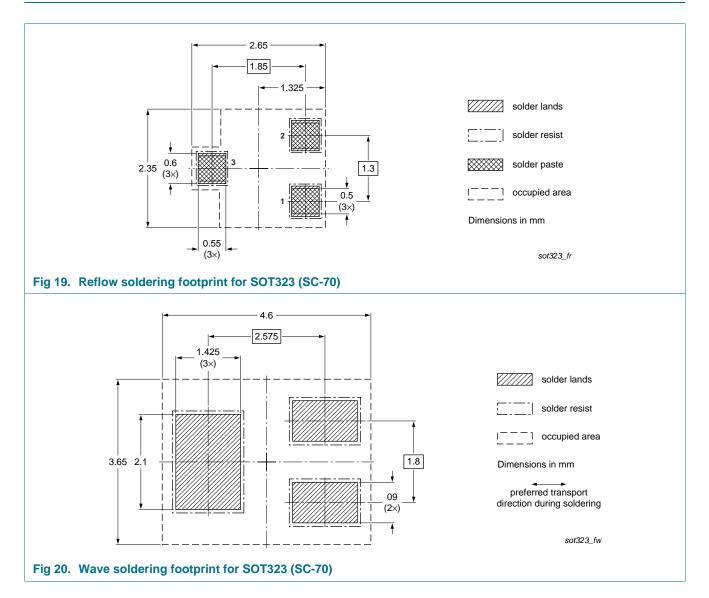
Fig 18. Package outline SOT323 (SC-70)

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10. Soldering



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11. Revision history

Table 8. Rev	Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
NX3008PBKW	v.1 20110801	Product data sheet	-	-	

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12. Legal information

12.1 Data sheet status

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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